

N-Channel 20 V (D-S) MOSFET

SOT-23 (TO-236)



Top View

Marking code: N2

PRODUCT SUMMARY	
V_{DS} (V)	20
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 4.5$ V	0.057
$R_{DS(on)}$ max. (Ω) at $V_{GS} = 2.5$ V	0.075
Q_g typ. (nC)	3.5
I_D (A)	2.9
Configuration	Single

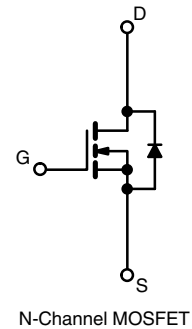
FEATURES

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
 COMPLIANT
 HALOGEN
FREE
 Available

APPLICATIONS

- Load switching for portable devices
- DC/DC converter



ORDERING INFORMATION	
Package	SOT-23
Lead (Pb)-free	Si2302CDS-T1-E3
Lead (Pb)-free and halogen-free	Si2302CDS-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)					
PARAMETER	SYMBOL	5 S	STEADY STATE	UNIT	
Drain-source voltage	V_{DS}	20	20	V	
Gate-source voltage	V_{GS}	± 8	± 8		
Continuous drain current ($T_J = 150$ °C) ^a	I_D	$T_A = 25$ °C	2.9	2.6	A
		$T_A = 70$ °C	2.3	2.1	
Pulsed drain current ^b	I_{DM}	10	10		
Continuous source current (diode conduction) ^a	I_S	0.72	0.6		
Power dissipation ^a	P_D	$T_A = 25$ °C	0.86	0.71	W
		$T_A = 70$ °C	0.55	0.46	
Operating junction and storage temperature range	T_J, T_{stg}	-55 to +150	-55 to +150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient ^a	R_{thJA}	$t \leq 5$ s	120	145	°C/W
		Steady state	140	175	
Maximum junction-to-foot	R_{thJF}	62	78		

Notes

- Surface mounted on 1" x 1" FR4 board
- Pulse width limited by maximum junction temperature



SPECIFICATIONS (T _A = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN.	TYP.	MAX.	
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	20	-	-	V
Gate-threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	0.40	-	0.85	
Gate-body leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 8 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V	-	-	0.1	μA
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 50 °C	-	-	4	
		V _{DS} = 20 V, V _{GS} = 0 V, T _J = 70 °C	-	-	15	
On-state drain current ^a	I _{D(on)}	V _{DS} ≥ 10 V, V _{GS} = 4.5 V	6	-	-	A
Drain-source on-resistance ^a	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 3.6 A	-	0.045	0.057	Ω
		V _{GS} = 2.5 V, I _D = 3.1 A	-	0.056	0.075	
Forward transconductance ^a	g _{fs}	V _{DS} = 5 V, I _D = 3.6 A	-	13	-	S
Diode forward voltage	V _{SD}	I _S = 0.95 A, V _{GS} = 0 V	-	0.7	1.2	V
Dynamic ^b						
Total gate charge	Q _g	V _{DS} = 10 V, V _{GS} = 4.5 V, I _D = 3.6 A	-	3.5	5.5	nC
Gate-source charge	Q _{gs}		-	0.6	-	
Gate-drain charge	Q _{gd}		-	0.45	-	
Gate resistance	R _g	f = 1 MHz	2	4	8	Ω
Switching						
Turn-on delay time	t _{d(on)}	V _{DD} = 10 V, R _L = 2.78 Ω I _D ≅ 3.6 A, V _{GEN} = 4.5 V, R _g = 1 Ω	-	8	15	ns
Rise time	t _r		-	7	15	
Turn-off delay time	t _{d(off)}		-	30	45	
Fall time	t _f		-	7	15	
Source-drain reverse recovery time	t _{rr}	I _F = 3.6 A, di/dt = 100 A/μs	-	8.5	15	nC
Body diode reverse recovery charge	Q _{rr}		-	2	4	

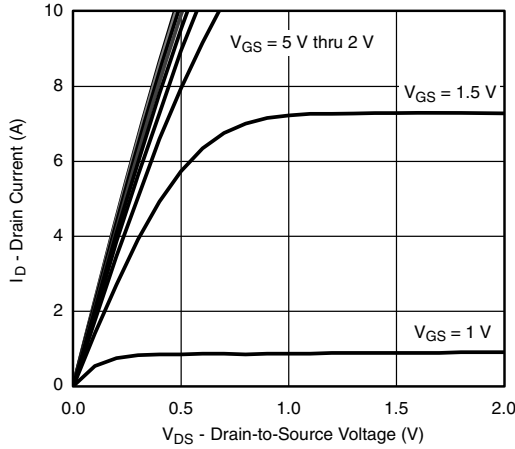
Notes

- a. Pulse test: Pulse width ≤ 300 μs, duty cycle ≤ 2 %
b. Guaranteed by design, not subject to production testing

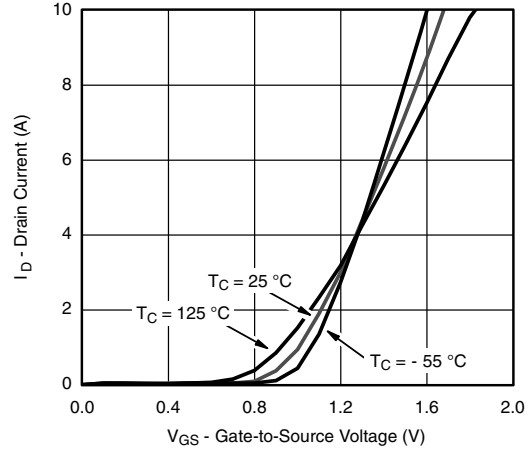
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



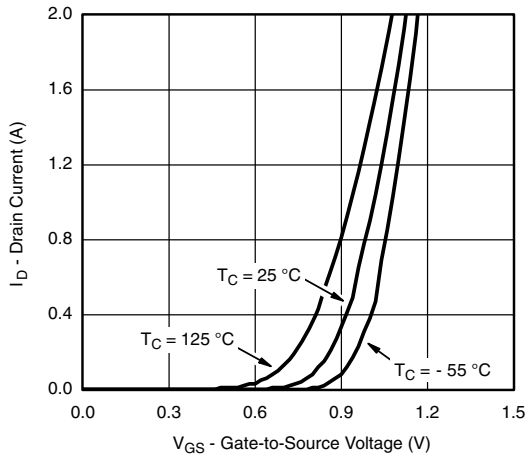
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



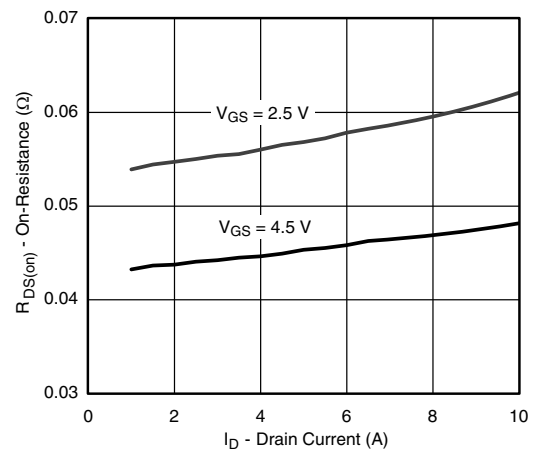
Output Characteristics



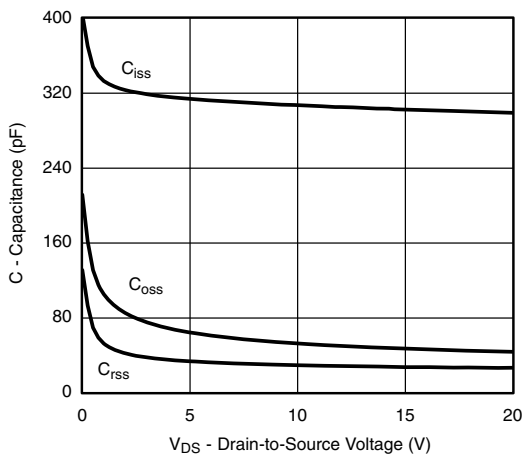
Transfer Characteristics



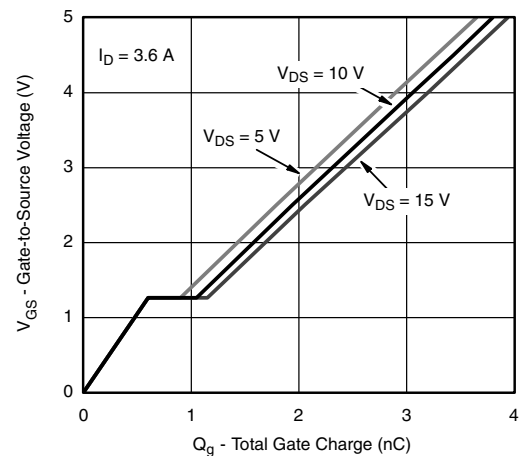
Transfer Characteristics



On-Resistance vs. Drain Current

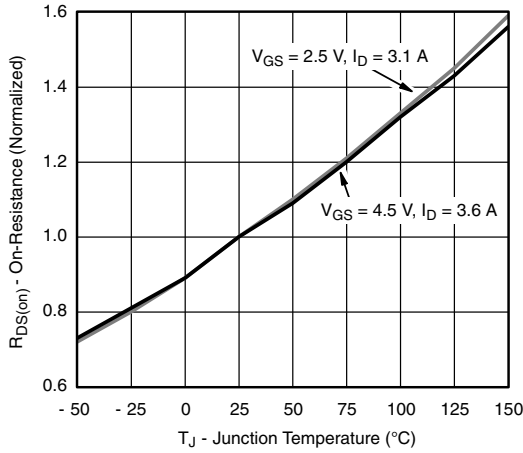


Capacitance

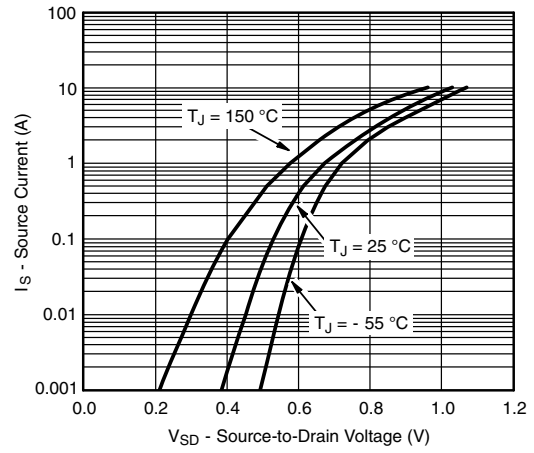


Gate Charge

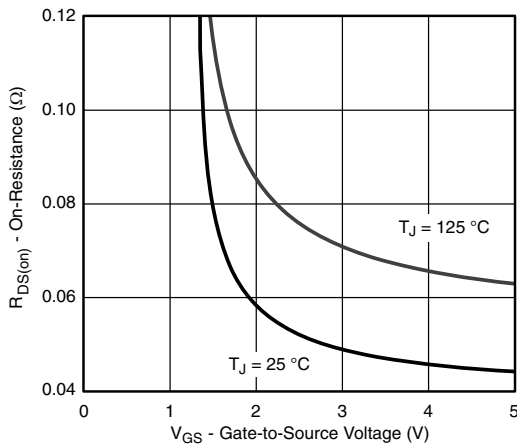
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



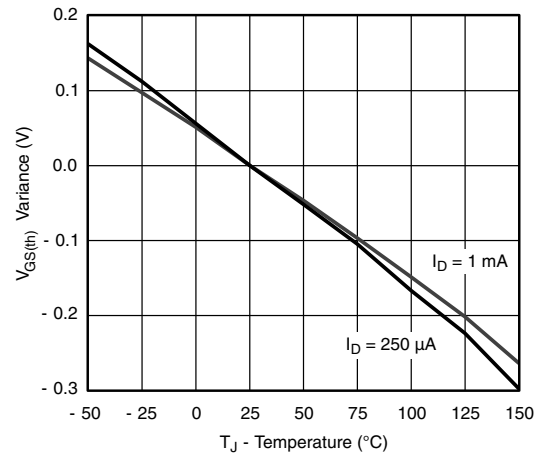
On-Resistance vs. Junction Temperature



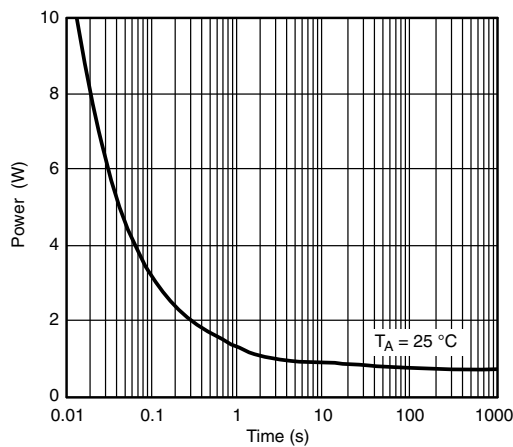
Source-Drain Diode Forward Voltage



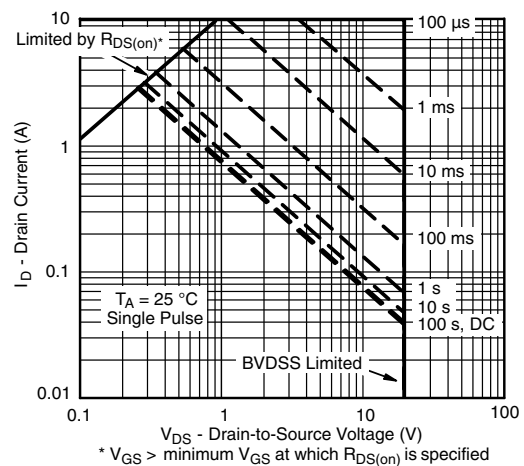
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



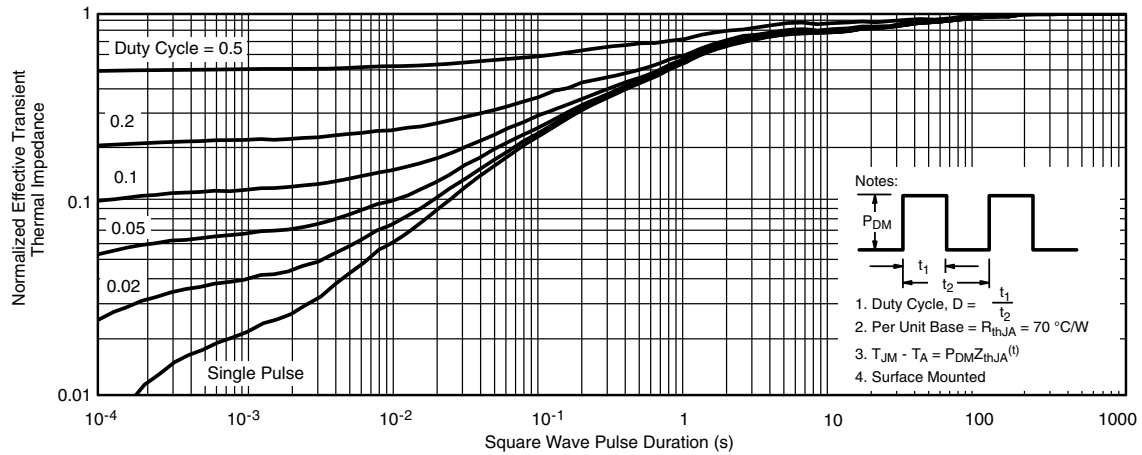
Single Pulse Power



Safe Operating Area, Junction-to-Ambient



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?68645.

SOT-23 (TO-236): 3-LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	0.89	1.12	0.035	0.044
A ₁	0.01	0.10	0.0004	0.004
A ₂	0.88	1.02	0.0346	0.040
b	0.35	0.50	0.014	0.020
c	0.085	0.18	0.003	0.007
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.083	0.104
E ₁	1.20	1.40	0.047	0.055
e	0.95 BSC		0.0374 Ref	
e ₁	1.90 BSC		0.0748 Ref	
L	0.40	0.60	0.016	0.024
L ₁	0.64 Ref		0.025 Ref	
S	0.50 Ref		0.020 Ref	
q	3°	8°	3°	8°

ECN: S-03946-Rev. K, 09-Jul-01
 DWG: 5479

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads
Dimensions in Inches/(mm)

[Return to Index](#)



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.